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DRL No. 135 Technical Report: MRI - 290 DOE/JPL - 955676-2_ Distribution Category UC - 63

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ANALYSIS OF DEFECT STRUCTURE IN SILICON

CHARACTERIZATION OF SAMPLES FROM UCP INGOT 5848-13C

Silicon Sheet Growth Development for the Large Area Silicon Sheet Task of the Low-Cost Solar Array Project.

INTERIM REPORT

by R. Natesh T. Guyer G. B. Stringfellow

August, 1982

JPL Contract No. 955676

The JPL Low-Cost Silicon Solar Array Project is sponsored by the U.S. Department of Energy and forms part of the Solar Photovoltaic Conversion Program to initiate a major effort toward the development of low-cost solar arrays. This work was performed for the Jet Propulsion Laboratory, California Institute of Technology, by agreement between NASA and DOE.



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SECTION I

SUMMARY

Statistically significant quantitative structural imperfection measurements were made on samples from Ubiquitous Crystalline Process (UCP) Ingot 5848 - 13C. Important trends were noticed between the measured data, cell efficiency, and diffusion length. Grain boundary substructure appears to have important effect on conversion efficiency of solar cells from Semix material. Quantitative microscopy measurements gives statistically significant information compared to other micro - analytical techniques. A surface preparation technique to obtain proper contrast of structural defects suitable for QTM analysis was perfected and is now being used routinely.

SECTION II

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INTRODUCTION

The objective of this work is to gain fundamental understanding of the role of structural imperfections and chemical impurities on solar cell performance.

The type, density, distribution, and electrical activity of such defects have significant effects on solar cell performance. Most of the processes designed to produce silicon crystals at low cost introduce a high density of defects in crystals, which have a distinct effect on solar cell efficiency.

The types of defects present in many of the low - cost silicon "sheets", produced by a variety of methodology, run the gamut from point defects to dislocations, planar defects such as twins and stacking faults, high and low angle grain boundaries, and second phase inclusions. The types of imperfections present and their density are a function of the specific method used for producing the silicon sheets.

In general, rapidly grown ribbon - type crystals produced by techniques such as the EFG process, the Web Dendritic method, etc., typically contain a relatively high population of dislocations usually arrayed along linear boundaries, a high density of twins, and chemical impurities in the form of precipitates. Sheets formed by slicing of cast crystals, such as SEMIX material, are generally polycrystalline in nature with grain diameters from a fraction of a millimeter to several millimeters, and twin boundaries oriented in different direction within many of the grains.

Quantitative analysis of surface defects was performed by using a Quantimet Quantitative Image Analyzer (QTM 720). The results were double checked by manually counting all the defects. The QTM 720 can differentiate and count 64 shades of grey levels between black and white contrasts. In addition, it can characterize structural defects by measuring their length, perimeter, area, density, spatial distribution, frequency distribution (in any preselected direction), and is programmable in these measurements. However, the QTM 720 is extremely sensitive to optical contrasts of various defects. Therefore, to obtain reproducible results, the contrasts produced by various defects must be similar and uniform for each defect types along the entire surface area of samples to be analyzed. To achieve this contrast uniformity, a chemical cleaning and polishing procedure was developed and perfected for the SEMIX samples described in this report. The cleaning and polishing procedure produced a very clean and even surface. <u>Statistically</u> significant quantitative data was measured and their significance is discussed.

ADVANTAGE OF QUANTITATIVE MICROSCOPY TECHNIQUE

There is significant advantage in using quantitative microscopy technique as described herein to analyze structural defects. Techniques such as transmission electron microscopy (TEM), scanning electron microscopy (SEM), while providing useful information, are usually performed at higher magnifications. For example, TEM analysis is usually carried out in the magnification range 10,000X to 300,000X. Because of the high magnification employed, the area of the field of view is very very small

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compared to the total surface area of the starting sample, such as a 2cm by 2 cm sample. Hence, the information obtained, although impressive, may not be <u>statistically significant</u>. However, in our quantitative microscopy technique as used in this report, the magnifications used are very low such as 100X to 1000X. In addition, a total of 62 fields was analyzed from a 2 cm by 2 cm sample. For grain boundary and twin boundary measurement, the total area analyzed was 1.49 cm² for a 2 cm by 2 cm sample i. e., a whopping <u>75%</u> of total surface area was actually measured. For precipitate particles, the total area analyzed was 0.09 cm² i. e., <u>2.3%</u> of the total surface area was measured. For dislocation pits, the total area measured was <u>0.33%</u> of the total sample area. By way of comparision, if we were to analyze 62 fields from a 2 cm by 2 cm sample by TEM technique at 100,000X, the total area measured will be only 0.00000147 cm² which is <u>0.000147%</u> of the sample surface area.

Therefore, the results obtained by quantitative microscopy technique as described in this report are <u>statistically more significant and reliable</u> than any other technique such as TEM, SEM, etc.

SECTION III

EXPERIMENTAL PROCEDURE

A. CHEMICAL POLISHING AND ETCHING

Eight (8) samples from SEMIX's Ubiquitous Crystalline Process (UCP) Ingot 5848 - 13C were received by Materials Research, Inc., (MRI) from JPL for characterization of structural defects. These samples measured 2 cm by 2 cm and were designated by JPL as A-13, B - 2, C - 12, D - 8, E-13, F - 2, G - 12, and H - 8. These samples were originally fabricated into solar cells by Optical Coating Laboratory, Inc. (OCLI). JPL then stripped the junctions off, mechanically polished these samples, and sent them to MRI for characterization.

The QTM 720 apparatus is extremely sensitive to contrasts produced by various structural defects. It can distinguish 62 shades of grey levels between black and white. By remembering the exact shade, the QTM 720 is able to correctly count each defect types. Therefore, to obtain accurate and reproducible results it is very important that each structural defect type be etched to <u>identical</u> contrast. MRI has now perfected a chemical cleaning, polishing, and etching procedure to produce contrasts to such a demanding requirement in these Semix samples. All chemicals used were Low Sodium MOS, Electronic Grade. The following procedures were used:

1)) <u>Grease</u> , <u>Dust and other Surface Contamination Removal</u>		
ä.	Sample immersed in trichloroethylene	time (min.) 3	
b.	Sample rinsed in acetone	3	
с.	Sample rinsed in 2- Propanol	3	
d,	Compressed N ₂ gas to blow off 2-Propanol to prevent stain marks	0.5	

2) Protective Coating Application

- Using a fine paint brush, Apiezon Wax dissolved in tria. chloroethylene was applied to one surface of the silicon sample.
- The wafer was then heated on a hot plate to about 120° C to b. accelerate evaporation of trichloroethylene. The Apiezon Wax melted and spread uniformly covering the entire surface. All of the trichloroethylene evaporated leaving behind a thin coating of the acid - resistant Apiezon Wax covering the surface.

		time (min.)
a,	Sample was immersed in concentrated HF	4
b.	It was then rinsed in distilled water	4
с.	It was then rinsed in 2-propanol	· 4
d.	N ₂ gas to blow off excess 2-propanol	0.5

3) Silicon Oxide Layer Removal

The protective coating application is done for two reasons: i) to prevent attack and dissolution of samples from two surfaces. By using a wax coating, the coated surface is prevented from chemical attack during polishing and etching procedure, ii) the protective coating may be dissolved later in trichloroethylene and JPL may in future build a solar cell on that surface. Thus a direct correlation between cell efficiency and defect densities for each sample may be obtained.

4) Chemical Polishing Procedure

'The chemical polishing solution is a mixture by volume of 1 part nitric acid (HNO_3): 2 parts hydrofluoric acid (HF): 3 parts acetic acid (CH_3COOH). The following procedure was used:

		time (min.)
а.	The wafer was immersed at 50 \pm 3 [°] C in polishing solution	0.1-0.75
b.	It was then rinsed in deionized distilled water	4
с.	It was then rinsed in 2 - propanol	- 4
d.	N ₂ gas blown to dry sample surface	0.5
e.	Sample was observed under micrscope and polishing was continued until a smooth flat surface was observed	0.1-0.75

5) Chemical Etching Procedure

The chemical etching solution consists of 2.5 gm. of chromium trioxide (CrO_3) dissolved in 15 ml. deionized distilled water

and 15 ml. concentrated hydrofluoric acid (HF). The following

procedure was used:

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		time (min.)
a.	Sample was immersed in the chemical etching solution	0.1-0.3
Ŀ.	It was then rinsed in deionized distilled water	4
c.	It was then rinsed in 2 - propanol	4
d.	N ₂ gas blown to dry sample surface	0.5
е,	Sample was observed under microscope and etching procedure was continued until dislocation pits are visibly observed	ł

The etching times for the Semix samples were as follows.

Sample No.	Etching Time (Sec.)
A-13	67
. B-2	60
C-12	48
D-8	37
E-13	77
F-2	82
G-12	61
H-8	48
Average	60

SECTION IV

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RESULTS AND DISCUSSION

A. MEASUREMENT' OF GRAIN BOUNDARIES, TWIN BOUND-

ARIES, PRECIDITATE PARTICLES, AND DISLOCATION

PITS

Using an Olympus Inverted Optical Metallurgical Microscope, Model PME, approximately 62 fields on each sample were analyzed for structural defects. Figure 1 shows the relative positions of the 62 fields that were observed on each sample. The feature under investigation is counted in each field and averaged over the 62 fields for a statistical average of the overall sample. The field of view of the microscope is a necessary quantity to know so that some dimensions can be given to the defect feature. Using a 0.01 cm - 0.001 cm calibrated standard microscope slide, the diameter of the field of view was measured at different magnifica-From this data, the circumference and the area of the field tions. of view was determined. This data is tabulated in Table 1. Table 1 shows that as the magnification approximately doubles for successive objective setting, the diameter of field of view decreases by about half.

The defect measurements were done in three (3) separate steps. First, the grain boundary and twin boundary intersections were

measured for all the 62 fields using a magnification of 100X in the polished condition. Next, the precipitate particles were measured for all the 62 fields using a magnification of 400X in the polished condition. Next, the sample was etched in the etching solution and immediately measurements were made for dislocation pits for all the 62 fields at a magnification of 1000X.

All of these measurements were made manually. Attempts were made to use the Quantitative Image Analyzer (Quantimet QTM 720). However, this was not successful since the contrast on the CRT was poor for the fine precipitates at 1000X. These manual measurements were done <u>very carefully</u>, the measurements were <u>repeated</u>, and found to be reproducible. All measured data is listed in Appendix.

1) <u>Measurement of Grain Boundary and Twin Boundary Length</u> Per Unit Area

Since grain boundaries can be location of efficient carrier recombination centers and act as sinks for impurities which can be detrimental to the efficiency of the solar cell, $^{1-4}$ the grain boundary length per unit area is an important quantity to know. Using a statistical method of counting the intersections of the grain boundaries and twin boundaries with a test line, the length per unit area can be calculated using the following relationship 5,6 :

- $L_A = (\pi/2) \cdot P_L$, where
- $L_A =$ line length of grain boundaries or twin boundaries per unit area (cm/ cm²)
- P_L = number of point intersections of grain boundaries or twin boundaries per unit length of test lines.

Figures 2, 6, 7, 8, 9, 12, 14, 16, and 17 show typical structures of twin boundaries and/or grain boundaries in the Semix samples. The Appendix Tables 1, 4, 7, 10, 13, 16, 19, and 22 contain a listing of the raw measured data for grain boundaries and twin boundaries. The information in the above tables has been summarized in Table II, along with calculated values for arithmetic mean and standard deviation.

Several tentative graphs are shown in order to determine any apparent relationship in the measured data. These graphs are preliminary and subject to revision as more and more samples are examined and better information about sample history is obtained from other sources (such as Semix Corporation, JPL, OCLI, etc.,). Figure 20 shows a plot of twin boundary length as a function of the distance of the wafer from top of the ingot. Figure 20 shows that, as a first approximation, twin boundary density (expressed as length/unit area) decreases as the distance from top of ingot increases. Samples A and E located at top of the ingot have the highest densities. To explain this phenomenon, data on crystal growth conditions are required. Figure 24 is a plot of the data listed in Table II. As a first approximation, Figure 24 shows that as the grain boundary length/unit area increases, the twin boundary length/unit area increases rapidly at first then levels off and decreases. To explain this observation, as the grain size decreases the grain boundary length/unit area increases. If on the average, the same number of twin boundaries were still present in the now-smaller grains, then the number of twin boundaries will also increase with a corresponding increase in twin boundary length/unit area. The dotted curve in Fig. 24 shows this trend.

2) Measurement of Precipitate Particles

The polished samples were observed at a magnification of 400X and the number of precipitate particles were counted in each There appeared to be two fairly distinct sizes of what field. was counted as precipitate particles. The large - sized defects were clearly recognized to be precipitate particles. However, there were smaller features, that could not be resolved clearly, which looked like precipitate particles. The only other possibilities were that these features are small stain marks or etch pits. Since there is some questions as to the identity of these features, observation of these samples at a higher magnification using a Scanning Electron Microscope (SEM) will be performed later. However, for the time being, these features will be regarded as small precipitates subject to correction later. The Appendix Tables 2, 5, 8, 11, 14, 17, 20, and 23 contain a listing of the raw measured data for precipitate particles in these Semix samples. The information contained in the above tables have been summarized in Table III, along with calcuvalues for arithmetic mean and standard deviation. Small and large precipitate particle densities are listed separately in Table III.

A sample calculation for small precipitate density in sample F-2 in

Table III is shown below:

Magnification = 4003	OF POOR QUALITY
Area of field $= 0.00$)149 cm ²
X for small precipitate =	$\frac{447}{62} = 7.2$
No. of small precipitates	(total no. of small precipitates counted)
unit area	(total no. of fields) (area of a field)
	$= \frac{(447)}{(62)(0.00149 \text{ cm}^2)} \text{ (see Appendix) Table 17)}$
	= 4.8×10^3 precipitates $/\text{cm}^2$

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Figures 3, 4, 5, 13, and 15 show precipitate particles on some of the Semix samples. The large precipitates are of the order of magnitude $\sim 2 \times 10^{-3}$ cm, while the small precipitates are of the order of magnitude $\sim 5 \times 10^{-4}$ cm and smaller.

3) Dislocation Density

After etching each of the Semix wafers, the dislocation density was determined by counting the number of dislocation etch pits at 1000X in each field of view for approximately 57 fields per sample. The number of fields measured was slightly lower due to mechanical interference of the longer objective lens with the microscope stage. The Appendix Tables 3, 6, 9, 12, 15, 18, 21, and 24 list the raw measured data

for dislocation number density. The information in the above tables have been summarized in Table III, along with calculated values for arithmetic mean and standard deviation. A sample calculation for wafer F-2 in Table III is as follows:

Magnification = 1000X
Total number of dislocation pits counted = 2334 from 59 fields
Area of Field = 0.000238 cm²
Dislocation Pit density =
$$\frac{(total no. of dislocation pits counted)}{(total no. of fields) (Area of field)}$$

= $\frac{(2334)}{(59) (0.000238 cm2)}$ (see Appendix Table 18)
= 1.7×10^5 dislocation pits/cm²

Figures 10, 11, 18, and 19 show dislocation arrangements in some of the Semix samples.

Figure 21 shows a plot of dislocation density versus large precipitate density from the data listed in Table III (data for small precipitate was not used in Figure 21 since the identity of small precipitate was not positively established). Figure 21 shows that as the large precipitate density increased from sample to sample, the corresponding dislocation density decreased. This trend is quite clear even though some anomalies are present in Figure 21. This observation may be explained on the basis

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that dislocation lines constitute tubes of fast diffusion, with a diffusion coefficient close to the coefficient of self diffusion along grain boundaries. The rates of diffusion along such short-circuit paths are significantly higher than for volume diffusion, since the associated activation energies are much lower than for volume diffusion⁸. As the density increases, larger number of short-circuit paths are now available for impurity atoms to migrate. This will result in a decrease in precipitate density. While the intrinsic properties of individual dislocations, dislocation networks, and grain boundaries are governed by the presence of space charge cylinders around defects, the typical electrical response of these structural defects is determined by the presence of impurities in association with the defects. The interaction energy between common impurities such as Fe, Ni, Cu and a dislocation are fairly high, so that impurity atmospheres and impurity precipitates can form at dislocations⁹. When defect intersections occur in crystals, the resulting electrical effects are more pronounced^{10, 11}. Presence of impurities at or near crystallographic defects make them electrically active. When P is diffused into the crystals, the impurities from the defects are "gettered" due to reactions between P and impurities decorating the defects. As a result, the defects are no longer electrically active. However, the defects are still present within a diffusion length of beamgenerated charge carriers. Hence, predominant electrical effects in silicon devices are caused by defect-impurity association (see Fig. 10, 11, &19).

B. POSSIBLE RELATIONSHIP BETWEEN CELL EFFICIENCY AND DEFECT DENSITY

Table IV lists the defect densities in these Semix samples as obtained by MRI along with the data for cell efficiency and diffusion length as obtained by OCLI⁷. The data for cell efficiency was plotted as a function of the observed data for different types of structural defects. Figure 22 shows a plot of cell efficiency versus twin boundary density. An approximate inverse relationship is observed. The significance of this graph is that the grain boundary substructure may influence cell efficiency in Semix material. In other words, the defect structure within grains may influence the cell efficiency more than the grain boundary itself. Furthermore, as mentioned in page 21, interactions of these substructures with one another and with impurity atmospheres may cause more pronounced electrical effects. It is proposed that MRI verify such effects by obtaining quantitative relationship during next year's effort. For example, MRI should determine what fraction of the total number of each defect types are electrically active. Also, quantitative data is required on total chemical impurities and the distribution of these impurities along the structural defects, cell junction, and cell surfaces. Neutron Activation Analysis is being performed on these samples, and the data will be sent to JPL next week.

C. <u>POSSIBLE RELATIONSHIP BETWEEN DIFFUSION LENGTH</u> AND DEFECT DENSITY

The numerical data for diffusion length was plotted in several ways using the various observed data for different types of structural defects listed in Table IV. Figure 23 shows a graphical plot of diffusion length versus observed dislocation density in the eight samples. The figure shows an important trend. An inverse relationship is observed between diffusion length and dislocation density. Since the average grain size in these samples is expected to be larger than the diffusion length in a single crystal Semix of the same doping level (data not currently available), the effective lifetime and diffusion length in the polycrystalline Semix samples is expected to be reduced by substructures within grains (such as twin boundary density, dislocation density, and precipitate particle density along with chemical segregation around these substructures). It is important that during next year's effort, MRI should generate quantitative information to establish definitive relationship on how diffusion length is influenced by density of structural defects in Semix. A similar study for other silicon materials studied by MRI¹²⁻²² for JPL will result in a fundamental understanding of the various silicon microstructures and substructures and their effect on electrical properties of solar cells.

D. NUMERICAL SIGNIFICANCE OF MEASURED DATA

The measured data for the Semix samples are listed in Appendix Tables 1 thru 24, and the information in these tables are summarized in Tables II, III, and IV. The defect structure characterization was done using a statistical sampling of each sample over a TV raster and from this an average value for each defect type in each sample was obtained.

Among these eight samples, the large precipitate density varied from 65 to 745 per cm², while the total (large and small) precipitate density varied from 2.7 \times 10³ to 23 \times 10³ per cm².

Grain boundary length per unit area varied from 4.5 to 13.8 cm/cm², whereas the twin boundary length per unit area varied from 12.2 to 99.0 cm/cm². Samples A-13 and E-13 had the higher twin boundary length per unit area, while the grain boundary length per unit area for these samples were in the middle range. Samples C-12, D-8, and G-12 had the higher numerical values for grain boundary length, but in the middle range for twin boundary length. Samples B-2 and F-2 had lower values for both grain boundary and twin boundary length. Figure 24 shows that as the grain boundary length/unit area increases, the twin boundary length/unit area also increases at first rapidly, but at higher values for grain boundary length/unit area, it levels off and gradually decreases.

Dislocation density in these samples varied from 4.9 $\times 10^4$ to 86 $\times 10^4$ /cm².

Sample A-13 had the lowest dislocation density but highest large precipitate density (see Table IV). Samples C-12, G-12, and H-8 had lower precipitate density but had higher dislocation density. Therefore, an approximate inverse relationship was observed between dislocation density and precipitate density as shown in Figure 21.

Sample A-13 had the highest twin boundary length per unit area as well as the highest large precipitate density. Figures 2 and 3 show some regions in this sample that illustrate this observation.

Figures 4 and 5 show some precipitate particles in fields free of twin boundaries and grain boundaries in sample B-2. This sample had lower twin boundary and grain boundary lengths per unit area but precipitate density was in the medium numerical value. Figures 6 and 7 show some twin boundary and grain boundary regions in sample C-12. Sample C-12 had higher grain boundary density. Sample D-8 had the highest grain boundary length per unit area and also a relatively high twin boundary density as illustrated in Figures 8 and 9. Figure 10 shows an area in sample D-8 where dislocations have piled up between twin boundaries Figure 11 shows another type of interaction between dislocations and a twin boundary. Such a boundary may be electrically active as discussed in page 21.

Figures 12 and 13 show a higher twin boundary density region, which is typical of sample E-13. Sample F-2 has a lower grain boundary and

twin boundary length per unit area, but a high precipitate density. Figure 14 shows interaction between twin boundary and grain boundary, and Figure 15 shows a region of higher precipitate density in sample F-2. Figures 16 and 17 show sample regions in sample G-12 with typical grain boundary and twin boundary structures. Sample H-8 has the highest dislocation density and typical areas are illustrated in Figures 18 and 19. In Figure 18, the dislocations form simple networks. Figure 19 shows linear arrays of dislocations interacting with twin boundaries on either side

The standard deviation from the mean for all of the defect types is of the same order of magnitude as the mean itself. This shows that there is a large variation in the distribution of defects from one field to another in the same sample.

SECTION V

CONCL USIONS

A chemical surface preparation technique to obtain proper contrast of structural defects suitable for QTM analysis of Semix samples was perfected, and is now being routinely used. Statistical quantitative techniques were applied to these samples with a good degree of confidence.

The samples examined had two distinct sizes of precipitate particles. The larger size particles were clearly identifiable (Fig. 4) and had diameters about 2×10^{-3} cm and larger. The smaller surface iregularities, which appeared like precipitates had sizes 5×10^{-4} cm and smaller. The smaller irregularities will be analyzed further to confirm that they are indeed precipitates.

The measured data indicated several important trends. The twin boundary density (expressed as length/unit area) decreases as a function of the distance from top of the ingot (Fig. 20). The dislocation density exhibited an inverse trend with respect to the large precipitate density (Fig. 21 and Table III). An approximate inverse relationship was observed between cell efficiency versus twin boundary density (Fig. 22). The significance of such a relationship is that the grain boundary substructure may influence cell efficiency in Semix material more

than grain boundary itself. An approximate inverse relationship was was observed between diffusion length and dislocation density (Fig. 23 and Table IV). The twin boundary density varied from 2 to 12 times the corresponding grain boundary density. Figure 24 shows that as the grain boundary density increases, the twin boundary density increases rapidly at first, then levels off, and gradually decreases.

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While the intrinsic properties of individual dislocations, dislocation networks, and grain boundaries are governed by the presence of space charge cylinders around defects, the typical electrical response of these structural defects is determined by the presence of impurities <u>in</u> <u>association</u> with the defects. The interaction energy between common impurities such as Fe, Ni, Cu, etc., and a dislocation are fairly high, so that impurity atmospheres and impurity precipitates can form at dislocations. When defect <u>intersections</u> occur in crystals (Fig. 10, 11, & 19), the resulting electrical effects are more pronounced.

Quantitative Microscopy observation gives data which is statistically more significant than data obtained from other types of microanalysis such as TEM, SEM, etc.

SECTION VI

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TABLE I

The circumference and the field of view on the Olympus Inverted PME Microscope

Eye- piece Lens	Object- ive Lens	Magnifi- cation	Diameter of field of view (cm)	Circum- ference of field of view (cm)	Area of field of view (cm ²)
10X	5X	50X	0.36	1,13	0.102
10X	10X	100X	0.175	0.55	0.0241
10X	20X	200X	0.089	0.28	0.00622
10X	40X	400X	0.0435	0.137	0.00149
10X	100X	1000X	0.0174	0.055	0.000238

Sample Calculation:

Circumference at 50X = πD = (π) (0.36 cm) = 1.13 cm Area of field of view at 50X = $\frac{\pi D^2}{4}$ = $\frac{\pi (0.36)^2}{4}$ = 0.102 cm²

TABLE II

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Grain Boundary and Twin Boundary Length Per Unit Area for the

Semix Samples

SEMIX Sample Number	Grain Boundary Length per unit area (cm/cm ²)	Twin Boundary Length per unit area (cm/cm ²)
A - 13	8.2 x = 2.9 $\sigma = 2.0$	99.0 $\bar{x} = 34.6$ $\sigma = 56.5$
B - 2	4.5 $\overline{x} = 1.6$ $\sigma = 2.2$	15.8 $\bar{x} = 5.6$ $\sigma = 9.3$
C - 12	13.4 $\vec{x} = 4.7$ $\sigma = 2.7$	31.9 $\bar{x} = 11.2$ $\sigma = 11.1$
D - 8	$ \frac{13.8}{x} = 4.8 \\ \sigma = 3.2 $	44.5 $\bar{x} = 15.6$ $\sigma = 17.1$
E - 13	$7.1 \\ x = 2.5 \\ \sigma = 2.1$	68.5 x = 24 o = 38
F - 2	5.4 x = 1.9 $\sigma = 2.6$	12.2 $\bar{x} = 4.3$ $\sigma = 6.8$
G - 12	$ \begin{array}{rcl} 12.1 \\ \overline{x} &= 4.2 \\ \sigma^{-} &= 2.6 \end{array} $	$ \begin{array}{rcl} 40.7 \\ \overline{\mathbf{x}} &= 14.3 \\ \sigma &= 15.5 \end{array} $
H - 8	9.4 $\bar{x} = 3.3$ $\sigma = 1.9$	35.9 $\bar{x} = 12.6$ $\sigma = 13.3$
Average	9.2	43.6

≤ features in all fields

 \mathbf{x} = arithmetic mean

Total number of fields

standard deviation = $\begin{bmatrix} 1 & \sum_{i=1}^{n} & (x_i - \overline{x})^2 \end{bmatrix}^{1/2}$

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TABLE III

Precipitate Particle and Dislocation Pit Density for Semix Samples

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SEM Sam Nur	IIX Precipitate ple (par aber	X Precipitate Particle Density le (particles/cm ²) er	Dislocation Pit Density (pits/cm ²)
A -	$ small 22 x 10^{3} \overline{x} = 33 \sigma = 36.5 $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\frac{4.9 \times 10^{4}}{5 \times 12}$ $\frac{6}{5} = 23$
В-	$2 \frac{19.5 \times 10^3}{x} = 29.1 \\ \sigma = 18.1$	$\begin{array}{c cccccc} 19.5 \times 10^3 & 444 & 20 \times 10^3 \\ \hline \mathbf{x} &= 29.1 & \overline{\mathbf{x}} &= 0.66 \\ \mathbf{\sigma} &= 18.1 & \mathbf{\sigma} &= 0.95 \end{array}$	$\begin{array}{r} 3 \\ 9.5 \times 10^{4} \\ \overline{\mathbf{x}} = 23 \\ \mathbf{\sigma} = 45 \end{array}$
C -	$\begin{array}{c} 6.2 \times 10^{3} \\ \hline x = 9.2 \\ \sigma = 7.7 \end{array}$	$2 \begin{vmatrix} 6.2 \times 10^{3} & 65 & 6.3 \times 10 \\ \overline{\mathbf{x}} &= 9.2 & \overline{\mathbf{x}} &= 0.1 \\ \mathbf{\sigma} &= 7.7 & \mathbf{\sigma} &= 0.4 \end{vmatrix}$	3^{3} 37×10^{4} $\overline{x} = 89$ $\sigma = 62$
D -	$\begin{array}{c} 2.5 \times 10^{3} \\ \overline{x} = 3.8 \\ \mathbf{c} = 4.0 \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c} 10 \times 10^{4} \\ \overline{\mathbf{x}} = 24 \\ \mathbf{\sigma} = 51 \end{array}$
E -	$\begin{array}{c c} 9.1 \times 10^{3} \\ \hline x &= 13.5 \\ \sigma &= 10.6 \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	0^{3} 37 x 10^{4} , x = 89 σ = 96
F -	$\begin{array}{c} 4.8 \times 10^{3} \\ \overline{x} = 7.2 \\ \sigma = 10.5 \end{array}$	$\begin{array}{c ccccc} 4.8 \times 10^{3} & 740 & 5.6 \times 10 \\ \overline{\mathbf{x}} &= 7.2 & \overline{\mathbf{x}} &= 1.1 \\ \mathbf{\sigma} &= 10.5 & \mathbf{\sigma} &= 2.1 \\ \end{array}$	$\begin{array}{c} 0^{3} \\ \overline{x} = 40 \\ \overline{s} = 111 \end{array}$
G -	$\begin{array}{c} 6.4 \times 10^{3} \\ \hline x = 9.6 \\ \mathbf{o} = 8.0 \end{array}$	$2 \begin{array}{c c} 6.4 \times 10^3 & 140 & 6.6 \times 10 \\ \hline \mathbf{x} &= 9.6 & \mathbf{x} &= 0.21 \\ \mathbf{\delta} &= 8.0 & \mathbf{\sigma} &= 0.41 \end{array}$	$\begin{array}{c} 0^{3} \\ 45 \times 10^{4} \\ \overline{x} = 108 \\ \sigma = 161 \end{array}$
н -	$8 \begin{array}{r} 9.5 \times 10^{3} \\ \overline{x} = 14.1 \\ \sigma = 10.9 \end{array}$	9.5 x 10 ³ 250 9.7 x 10 $\overline{x} = 14.1$ $\overline{x} = 0.4$ $\sigma = 10.9$ $\sigma = 0.8$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$
Avg	. 10.0×10^3	10.0×10^3 367 10×10^3	³ 31 x 10 ⁴

For precipitate particle density, 2.3% of the total area was measured. For dislocation pit density, 0.33% of the total area was measured.

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TABLE IV

Defect Density, Conversion Efficiency, and Diffusion Length of Semix Samples.

SEMIX Sample number	Large preci- pitate density (cm ⁻²)	Dislocation pit density (cm ⁻²)	Grain bound- ary length per unit area (cm ⁻¹)	Twin bound- ary length per unit area (cm ⁻¹)	Cell effici- ency* (%)	Diffusion length [*] (jum)
A - 13	745	4.9 x 10^4	8.2	99.0	7.2	53
B - 2	444	9.5 $\times 10^4$	4.5	15.8	10.0	51
C - 12	65	37×10^4	13.4	31.9	9.7	41
D - 8	152 [.]	10×10^4	13.8	44.5	10.8	47 .
E - 13	400	37×10^4	7.1	68.5	6.2	35
F - 2	740	17×10^4	5.4	12.2	9.6	22
G * 12	140	45×10^4	12.1	40.7	9.5	19
H - 8	250	86×10^4	9.4	35.9	10.7	31

*data as given in reference No. 7.


<u>Figure 1.</u> Relative Positions of the Measured Fields on the Semix Wafers.



Fig. 2 Region Showing High Twin Density in Semix A-13(50X)



Fig. 3 Region Showing a Large Number of Precipitates in Semix





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Fig.5 Precipitates in Semix B-2 (530X)



Fig. 6 Many Grains and Grain Boundaries in Semix C-12 (50X)

Fig. 7 Twin and Grain Boundaries in Semix C-12 (50X)

Fig. 8 Large Number of Small Twin Boundaries in Semix D-8. These are not Typical Regions (66X). Region marked "U".

Fig. 10 Dislocations Piled up Between Twins due to Localized Strain in Semix D-8 (600X) ORIGINAL PAGE IS

Fig.11 Dislocations Interacting with a Twin Boundary in Semix D-8 (1500X)

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Fig. 12 High Twin Density in Semix E-13 (50X)

Fig. 13 Large Precipitate Particle Between Twins in Semix E-13 (530X)

Fig. 16 Twins and Grain Boundaries in Semix G-12 (50X)

Fig. 17 Region of High Twin Density in Semix G-12 (100X)

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Fig. 19 High Dislocation Density Between Twins in Semix D-8 (1330X)

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SECTION VII

APPENDIX

TABLES 1 THRU 24 LISTS ACTUAL DATA

MEASURED

TABLE 1.Grain Boundary and Twin Boundary DensitySAMPLESEMIX A-13.Sample in polished condition. Magnification 100X.Field area = 0.0241 cm^2 . Circumference of test circle = $\pi \cdot D = 0.55 \text{ cm}$.A denotes No. of grain boundary intersections with circumference of test circle.B denotes No. of twin boundary intersections with circumference of test circle.X and Y denotes field location of the data measured.

FIE	LD		А	No. of twins	в	FIE	LD		A	No. of twins	В	
Y	No.	X				Y	No.	x				
12	1	33	7	33	24	10	40	41	4	14	12	
12	2	35	7	28	37	10	41	38	2	112	198	
12	3	37	2	137	201	10	42	35	6	21	24	
12	4	39	4	12	23	8	43	34	5	33	42	
12	5	41	2	113	119	8	44	36	2	29	41	
12	6	43	2	9	14	. 8	45	38_	4	144	257	
12	7	45	3	15	10	8	46	40	2	12	22	
12	8	47	6	26	31	8	47	42	2	20	9	
12	9	49	0	0	0	8	48	44	2	0	0	
12	10	51	0	0	0	8	49	46	0	15	30	
14	11	50	2	0.	0	8	50	48	4	63	29	
14	12	47	2	12	12	8	51	50	2	7	11	l
14	13	44	0	2	4	6	52	49	4	29	33	
14	14	41	2	124	196	6	53	46	0	13	23	
14	15	38	2	19	33	6	54	43	2	5	9	
14	16	35	7	40	47	6	55	40	4	20	24	
16	17	34	0	0	0	6 55 40 4 20 24 6 56 37 4 38 62						
16	18	36	3	27	28	4	57	37	6	117	148	
16	19	38	3	12	15	4	58	39	2	100	160	
16	20	40	5	50	47	4	59	41	3	42	37	
16	21	42	2	1	2	4	60	43	2	3.	4	
16	22	44	2	8	8	4	61	45	0	0	0	
16	23	46	4	9	8	4	62	47	0	2	4	
16	24	48	0	Ó	0		1.6	1			1	l
16	25	50	2	0	0	Tot	al ior	04	179	1688	2145	
18	26	49	3	20	6	, 11ej						
18	27	46	5	14	9		f		harre	π.	<u>π</u> 1	79
18	28	43	2	4	6	A ^{LL} A	tor 8	rain	boun	uary=-2	LOYI)(0-35) ² 8.2
18	29	40	4	6	11						,	
18	30	37	6	' 8	4	· ·	fa= +		- E	Π.	2145	. an cm/
20	31	37	4	39	19	A ^L A	IOP TV	VIII C	ounda	(2)	(2)(0.55)	; 77 - 77
20	32	39	2	10	8							
20	33	41	3	3	3	X for grain boundary 2.9						
20	34	43	2	2	2		or gi		bound	ary=2.9		
20	35	45	0	1	2	σι	or gr	aini	bounda	ary= 2.0		
20	36	47	2	0	0		•		1			
10	37	50	8	32	3		or tw	in be	ounda	ry = 54.6		
10	38	47	5	24	25	στ	or tw	in bo	ounda	ry = 50.5		
10	39	44	2	9	9							

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2 ×62× 0.55

density calc

tables

TABLE 2 Precipitate Particle Density

 $\frac{\text{SAMPLE}}{\text{Field area}} = 0.00149 \text{ cm}^2$

A denotes No. of Large precipitates observed in field of view,

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIE	LD		A		В	FIE	ELD		A		в		
Y	No.	X				Y	No.	X					
12	1	33	1		15	8	40	37	0		9		
12	2	34	1		7	8	41	38	2		22		
12	3	35	0		67	8	42	39	0		69		
12	4	36	0		42	8	43	40	0		124		
12	5	37	2		32	8	44	41	0		69		
12	6	38	2		89	8	45	42	2		38		
12	7	39	1		15	8	46	43	0		11		
12	8	40	0		1,8	8	47	44	0		1		
12	9	<u>41</u>	0		19	8	48	45	1		3		
12	10	42	0		19	8	49	46	0		2		
12	11	43	0		9	88	50	47	0		9		
12	12	44	0		26	8	51	48	0		13		
12	13	45	1		9	8	52	49	3		3		
12	14	46	0		118	8	53	50	3		7		
12	15	47	1		187	8 54 51 1 6							
12	16	48	7		98	4 55 38 1 32							
12	17	49	2		136	4	56	40	0		21		
12	18	50	2		28	4	57	42	0		25		
12	19	51	0		40	4	58	44	1		40		
16	20	34	2		35	4	59	46	2		14		
16	21	35	0		30	20	60	38	0		11		
16	22	36	1		11	20	61	40	0		46		
16	23	37	5		3	20	62	42	1		6		
16	24	38	0		20	Tota	al for	64	71		2107		
16	25	39	1		24	fiel	da	01			2201		
16	26	40	0		46						2		
16	27	41			60	Are	a of 6	64 fi	elds =	= 0.09536	cm ⁻		
16	28	42	1		21	No.	of la	rge I	ppt. =	71/0.0	9536 2		
16	29	43			11	-	_		=	745/ cm	-		
16	30	44	3		24	X fo	or lar	ge p	pt. =	1.1			
16	31	45	1		32	σ fo	r lar	ge p	pt. =	1.5			
16	32	46	0		5	No.	of sm	nall j	ppt. =	2107/0.	0 95 36		
16	33	47	1		102	$= 22095 / cm^2$							
16	34	48	<u> </u>		23	X fo	r sm	all p	pt. =	33.0			
16	35	49	4		17	σfo	r sm	all p	pt. =	36.5			
16	36	5.0	6		9								
16	37	51	1		14								
8	38	35.	0		27			I	ORIGIN	AL PAGE	5		
8	39	36	0		12	OF POOR QUALITY							
20	63	44	3		8					· · · · · ·			
20	64	40	4		18								

TABLE 3DISLOCATION DENSITYSAMPLESEMIX A-13.Sample in etched conditionMagnification 1000X, Area of field = 0.000238 cm²X and Y denote the location of microscope stage (field of view) for the
data measured.

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FIE	LD		No. of	f Disloc Pits	ation	FI	ELD		No.	of Disloc Pits	ation			
Y	No.	X		*		Y	No.	X		4				
12	1	34		45		10	40	41		1				
12	2	35		46		10	41	38		75				
12	3	37		6		10	42	35		2				
12	4	39		5										
12	5	41		1		8	44	36		4				
12	6	43		6		8	45	38		5				
12	7	45		3		8	46	40		8				
12	8	47		5		8	47	42		1				
12	9	49		8		8	48	44		5				
12	10	50		4		8	49	46		2				
14	11	49		2		8	50	48	ļ	<u> </u>				
14	12	47		6		8	51	49		0				
14	13	44		4		6	52	49		1				
14	14	41		104		6	53	46		4				
14	15	38		118		6	54	43		6				
14	16	35		26		6 55 40 7								
16	17	35	+	14		6	56	37		6				
16	18	36	<u>├</u> †	5	1			1	1					
16	19	38		1		5	58	39	1	2	-			
16	20	40	<u> </u>	22	1	5	59	41	1	4				
16	21	42	<u>├</u>	4		5	60	43	1	3				
16	22	44		3		5	61	45	ſ	4				
16	23	46		3										
16	24	48		2			to 1 for		1	(01				
16	25	49		19			tal IOI	58		681				
18	26	47		5			108;							
18	27	46				Di	slocat	ion d	lensit	v				
18	28	43		0							2			
18	29	40		9		=	681/(5	58)(0	0002	38) pits/:	cm ⁻			
18	30	37				-	4.9 x	10^{4}	bits	/cm ² ,				
		ļ	↓↓			H	_ / .		1	z - 141				
19	32	39		_16	·	X	= 12							
19	33	41	ļ	6	·	6	= 23							
19	34	43	↓	15		H								
19	35	45				4								
19	36	47		8				_						
10	37	50		3		1		(-	RIGIN	al page	15			
10	38	47		3	1	Li I		C	F PO	DR QUALIT	Y			
10	39	44		0					s					

TABLE 4Grain Boundary and Twin Boundary DensitySAMPLESEMIX B-2Sample in polished condition. Magnification 100X.Field area = 0.0241 cm^2 . Circumference of test circle = $\pi \cdot D = 0.55 \text{ cm}$.A denotes No. of grain boundary intersections with circumference of test circle.B denotes No. of twin boundary intersections with circumference of test circle.X and Y denotes field location of the data measured.

FIE	LD		A	No. of twins	в	FIE	ELD		A	No. of twins	в	
Y	No.	X				Y	No.	X				
12	1	33	7		15	10	40	41	2		0	
12	2	35	3		25	10	41	38	2		4	
12	3	37	0		0	10	42	35	4		17	
12	4	39	0		4	8	43	34	7		16	
12	5	41	0		2	8	44	36	6		25	
12	6	43	0		0		45	38	4		7	
12	7	45	0	L	0	8	46	40	2		0	
12	8	47	0		0	8	47	42	0		0	
12	9	49	0		0	8	48	44	0		0	
12	10	51	4		29	8	49	46	0		7	
14	11	50	0		0	8	50	48	٥		17	
14	12	47	0		0	8	51	50	3		7	
14	13	44	0	.,	0	6	52	49	.0		3	
14	14	41	0		4	6	53	46	0		0	
14	15	38	0		0	6	54	43	0		0	
14	16	35	6		1	6	55	40	5		3	
16	17	34	8		3	6	56	37	2		0	
16	18	36	3		6	4	57	37	5 -		10	
16	19	38	2		4	4	58	39	4	1	6	
16	20	40	0		0	4	59	41	2		7	
16	21	42	0	••••••••••••••••••••••••••••••••••••••	0	4	60	43	0		0	
16	22	44	0		4	4	61	45	0		1	
16	23	46	0		0	4	62	47	0		2	
16	24	48	0		0							
16	25	50	0		0	Tota	al ior	62	98		347	
18	26	49	0		0	nei	as;					
18	27	46	0		7		6		1	π	π ×9	8
18	28	43	0		Ó		lor g	rain	bound	$ary=\frac{1}{2}xP$	L 2x6	2×0.55 4.51 Cm
18	29	40	2		4							
18	30	37	2		3		e			TX	342	
20	31	37	2		8		lor tw	nn p	ounda	ry=2_x6	2 × 0.55	15.75 Cuz
20	32	39	2		30							
20	33	41	2		8			- 1 - 1	1 .			
20	34	43	1		6		or gr		bounda	ry = 1.6		
20	35	45	0		0	σ ⁻ 10	or gra	in c	ounda	ry = 2.2		
20	36	47	0		0	$\overline{\nabla}$		- L				
10	37	50	6		50		or twi	in DO	undar	y = 5.6		
10	38	47	0		2	σια	or twi	n bo	oundar	y = 9.3		
10	39	44	0		0							
					-			~	DICINIA	PAGE IS	5	
								U			i	

TABLE 5Precipitate Particle Density

 $\overline{SAMPLE} SEMIX B-2. Sample in polished condition. Magnification 400X.$ Field area = 0.00149 cm²

A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

											_		
FIE	LD		А		в	FIE	LD		A		В		
v	No.	x				Y	No.	x					
12	1	33	2		14	10	40	41	0		9		
12	2	35	0		24	10	41	38	1		22		
12	3	37	0		18	10	42	35	0		31		
12	4	39	1		18	8	43	34	0		19		
12	5	41	0		25	8	44	36	1		17		
12	6	43	0		22	8	45	38	0		22		
12	7	45	1		11	8	46	40	1		16		
12	8	47	0		71	8	47	42	0		33		
12	9	49	0		31	8	48	44	1		16		
12	10	51	0		27	8	49	46	0		66		
14	11	50	0		34	8	50	48	0		59		
14	12	47	3		86	. 8	51	50	0		59		
14	13	44	2		23	6 52 49 0 27							
14	14	41	1		32	6 53 46 0 22							
14	15	38	0		44	6	54	43	0		18		
14	16	35	0		38	6	55	40	1		14		
16	17	34	i		13	6	56	37	1		15		
16	18	36	0		14	4	57	37	0		25		
16	19	38	0		35	4	58	39	2		95		
16	20	40	2		13	4	59	41	0	·	36		
16	21	42	0		23	4	60	43	1		64		
16	22	44	0		17	4	61	45	0		40		
16	23	46	0		38	4	62	47	0		29		
16	24	48	0		15	TT a bi		62	41		1802		
16	25	50	1		36		al lor	02	- T T		1000		
18	26	49	3		13	nei					2		
18	27	46	3		48	Are	ea of (62 fi	elds	= 0.0923	8 cm		
18	28	43	2		23	No.	of la	rge	ppt. =	41 /0.0	19238		
18	29	40	0		9				=	444/ cm	1"		
18	30	37	2		27	X fo	or lar	ge p	pt. =	0.66			
20	31	37	4		34	σfe	or lar	ge p	pt. =	0.95			
20	32	39	0.		28	No.	of sn	nall	ppt. =	1802 /0.	09238		
20	33	41	0		20				=	19506 / c	m ²		
20	34	43	1		39	X fo	or sm	all 1	ppt. =	29.1			
20	35	45	0		14	o r fo	or sm	ali j	ppt. =	18.1			
20	36	47	1		13								
10	37	50	1		27								
10	38	47	1		14								
10	39	44	0		17		,	ORI	GINAL	PAGE IS			

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TABLE 6DISLOCATION DENSITYSAMPLESEMIX B-2.Sample in etched conditionMagnification 1000X, Area of field = 0.000238 cm²X and Y denote the location of microscope stage (field of view) for the
data measured.

FIE	LD		No. of Disloc: Pits	ation	FIE	LD		No.	of Disloca Pits	ation	
Y	No.	X	+		Y	No.	X		•		
12	1	34	10		10	40	41		21		
12	2	35	7		10	41	38	,	1		
12	3	37	30		10	42	35		6	ļ	
12	4	39	10		8	43	35				
12	5	41	7		8	44	36		3		
12	6	43	8		8	45	38		34		
12	.7	45	22		8	46	40		183	+	
12	8	47	8		8	47	42		13		
12	9	49	69		8	48	44		25		
12	10	50	61		8	49	46		18		
14	11	49	47		8	50	48_		14		
14	12	47	48		8	51	49				
14	13	44	10		6	52	49		2		
14	14	41	6		6	53	46		5		
14	15	38	13		6	54	43		1	+	
14	16	-35	1		6	55	40		3	4	
16	17	35	1		6	56	37		5		
16	18	36	0		5	57	38				
16	19	38	28		5	58	39		7		
16	20	40	2		5	59	41		6		
16	21	42	16		5	60	43		14		
16	22	44	7		5	61	45		12		
16	23	46	16		5	62	47		15		
16	24	48	6		Tot	al for	56	<u>.</u>	1266		
16	25	49	13		fial	qa. 	50		200		
18	26	47	17			and the spannet					
18	27	46	24	<u> </u>	Dis	locat	ion č	lensity	ý	` ∩	
18	28	43	2	↓∤	=	1266/	(56) (0,000	238) pits	/cm ²	
18	29	40	5		= (0.95	\mathbf{x} 1	0 ⁵ pit	s/cm ^Z		
18	30	37	0		1	r		•	•		
19	31	37			x	= 23					
19	32	39			6	= 45					
19	33	41	9		-						
19	34	43	52								
19	35	45	20	 							
19	36	47		ļ		n	RIGI	AL P	AGE IS		
10	37	50	294			n n	FPC	OR OL	JALITY,		
10	38	47	5								
10	39	44	4								

TABLE 7 Grain Boundary and Twin Boundary Density

SAMPLE SEMIX C-12. Sample in polished condition. Magnification 100X. Field area = 0.0241 cm². Circumference of test circle = $\pi \cdot D$ = 0.55 cm. A denotes No. of grain boundary intersections with circumference of test circle. B denotes No. of twin boundary intersections with circumference of test circle. X and Y denotes field location of the data measured.

FIE	LD		А	No. of twins	в	FIE	ELD		A	No. of twins	в	
Y	No.	X	I .	[Y	No.	x				
12	1	33	8	17	11	10	40	41	4	45	57	2
12	2	35	10	20	24	10	41	38	10	9	8	
12	3	37	3	14	19	10	42	35	2	19	22	
12	4	39	2	24	30	8	43	34	7	17	15	
12	5	41	4	25	32	8	44	36	0	13	26	
12	6	43	4	2	2	8	45	38	6	19	22	
12	7	45	8	1	1	8	46	40	8	15	12	
12	8	47	0	0	0	8	47	42	0	8	9	
12	9	49	4	5	5	8	48	44	4	28	15	
12	10	51	6	9	8	8	49	46	4	6	3	
14	11	50	10	29.	11	8	50	48	6	11	11	
14	12	47	7	11	4	8	51	50	2	3	6	
14	13	44	5	6	5	6	52	49	5	9	12	
14	14	41	2	9	10	6	53	46	7	12	7	ſ
14	15	38	5	11	18	6	54	43	0	22	25	
14	16	35	9	22	16	6	55	40	3	38	43	
16	17	34	3	2	2	6	56	37	0	8	10	
16	18	36	3	7	6	4	.57	37	0	3	6	
16	19	38	7	6	6	4	58	39	3	11	14	
16	20	40	8	8	6	4	59	41	8	59	29	
16	21	42	4	3	6	4	60	43	3	22	22	
16	22	44	2	2	4	4	61	45	4	11	4	
16	23	46	3	1	1	4	62	47	4	3	2	
16	24	48	7	5	4	Tet	1	62	200	722	6.02	l .
16	25	50	4	28	25		ai ior de.	04	290	(25	093	
18	26	49	8	20	15	. Her	us:					
18	27	46	9	3	2	т	forg	rain	hound	π	$-\pi$	290 - 10.25 Cm
18	28	43	4	1	1	A	IOI g	1411	bound	2	L 2 ×6	2 ×0.55 2 13,36 Cm2
18	29	40	3	2	1							
18	30	37	3	11	10	T T	for th	vin h	chunda	π ×	693	- 71.97 Cm
20	31	37	7	3	3	L'A'		viii O	ounua	2 *	62 × 0.55	Cm2
20	32	39	3	6	6						•	
20	33	41	5	0	0	$\overline{\mathbf{v}}$	or ar	ain	bound	A 7		
20	34	43	5	2	4	ي م م ج	or ar	am i ain i		$x_{y} = 2.7$		
20	35	45	7	0	0	010	or gro			· · y ··· <i>L</i> · /		
20	36	47	5	<u>1</u>	1	T F	on tur	in he	undar	w = 11.2		
10	37	50	2	5	4		or tw	in bo	unda -	y = 11.2		
10	38	47	4	6	5	U U L	UI IW	TT DC	Junual	y — 11.1		
10	39	44	7	5	5							
									-			

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TABLE 8Precipitate Particle Density

SAMPLE SEMIX C-12 Sample in polished condition. Magnification 400X. Field area = 0.00149 cm^2

A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIE	LD		А		В	FI	ELD		A		В
Y	No.	x				Y	No.	X			
12	1	33	4		0	10	40	41	1		0
12	2	35	11		0	10	41	38	0		0
12	3	37	8		0	10	42	35	3		0
12	4	39	7		0	8	43	34	6		0
12	5	41	7		0	8	44	36	7		0
12	6	43	12		0	8	45	38	0		0
12	7	45	15		0	8	46	40	3		0
12	8	47	4		0	8	47	42	0		0
12	9	49	10		0	8	48	44	5		0
12	10	51	14		0	8	49	46	6		0
14	11	50	8			8	50	48	10		0
14	12	47	10		0	8	51	50	7		0
14	13	44	15		0	6	52	49	20		0
14	14	41	5		0	6		1			
14	15	38	14		0	6	54	43	5		0
14	16	35	12		0	6	55	40	12		2
16	17	34	19 ·		0	6	56	37	8		0
16	18	36	4		0	4	57	37	18		0
16	19	3.8	6		0	4	58	39	16		0
16	20	40	0		0	4	59	41	26		0
16	21	42	2		• 0	4	60	43	5		0
16	22	44	0		0	4	61	45	22		2
16	23	46	17		0	4	62	47	35		0
16	24	48	27		0	To	tal for	. 62	572		6
16	25	50	10		0	fie	lde.	. 02	514		0
18	26	49	18		0		100.				2
18	27	46	13		0	Ar	ea of	62 fi	elds	= 0.0923	8 cm
18	28	43	7			No	of la	rge	ppt. =	6 /0. ()9238
18	29	40	29	· · · · · · · · · · · · · · · · · · ·	<u> </u>	-			=	65 / cn	ດີ
18	30	37	8		0	X I	or la	ge p	pt. =	0.1	•
20	31	37	4		0	σ	or la	ge p	pt. =	0.4	
20	32	39	8			No	of sr	nall	ppt. =	572 /0.	09238
20	33	41	3.		0	-			=	6192 / 0	m"
20	34	43	3	 	0		or sm	all p	opt. =	9.2	
20	35	45	2	<u> </u>	0	. o ri	or sm	all I	opt. =	7.7	
20	36	47	.0		0						
10	37	50	3		0						
10	38	47	9	·	0						
10	39	44	2		0						

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TABLE 9DISLOCATION DENSITYOF POOR QUESAMPLESEMIX C-12. Sample in etched conditionMagnification 1000X, Area of field = 0.000238 cm²X and Y denote the location of microscope stage (field of view) for the
data measured.

aria.

FIE	LD		No. c	of Disloc Pits	ation	FIE	LD		No.	of Disloca Pits	ition
Y	No.	x		+	11	Y	No.	x		¥	
12	1	34		26		10	40	41		104	
12	2	35		187	11	10	41	38		149	
12	3	37		114	<u>† – – – †</u>	10	42	35		132	
12	4	39		58	11	8	43	35		89	
12	5	41		17	11	8	44	36		170	
·12	6	43		33		8	45	38		97	
12	7	45		29		8	46	40		59	
12	8	47		101		8	47	42		75	
12	9	49		15	1	8	48	44		99	
12	10	50		11		8	49	46		143	
14	11	49		55		8	50	48		35	L
14	12	47		162		8	51	49	and the second	83	
14	13	44		11		6	52	49			
14	14	41		20		6	53	46		81	
14	15	38		185		6	54	43		121	
14	16	35		253	1	6	55	40		108	
16	17	35		136	1	6	56	37		133	<u> </u>
16	18	36		82	1	5	57	38		66	1
16	19	38		205		5	58	39	{	96	1
16	20	40		37		5	59	41	1	152	
16	21	42		52		5	60	43	1	73	1
16	22	44		52		5	61	45		45	
16	23	46		47	· · · · · · · · · · · · · · · · · · ·	5	62	47			
16	24	48		44				56	l	1080	
16	25	49		177			al lor	00		4909	•
18	26	47		265			ав: -				
18	27	46		34		Dis	locat	ion d	lensity	7	
18	28	43	ļ	90			1000/	1561	0 000	228 miles /s	2
18	29	40		43		= 4	EYOY/	(20)(5	, 2	
18	30	37	ļ	31		= 3	3.7 x	: 1.0	pits,	/cm ⁻ .	
19	31	37	ļ	ļ		x	= 89				
19	32	39	ļ	ļ		6	= 62				
<u>19</u>	33	41	ļ	10							
19	34	43		8							
19	35	45	ļ								
19	36	47									
10	37	50		165							
10	38	47	L	82							
10	39	44	1	48	1						

TABLE 10
SAMPLEGrain Boundary and Twin Boundary DensitySAMPLESEMIX D-8.
Sample in polished condition. Magnification 100X.Field area = 0.0241 cm². Circumference of test circle = $\pi \cdot D$ = 0.55 cm.A denotes No. of grain boundary intersections with circumference of test circle.B denotes No. of twin boundary intersections with circumference of test circle.X and Y denotes field location of the data measured.

$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	FIE	ELD		А	No. of twins	В	FIE	LD		А	No. of twins	в			
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Y	No.	X				Y	No.	x						
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	12	1	33	10	89	23	10	40	41	6	22	10			
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	12	2	35	3	3	6	10	41	38	6	0	0			
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	12	3	37	4	9	8	10	42	35	5	24	17			
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	12	4	39	4	2	1	8	43	34	8	58	37			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	12	5	41	4	8	8	8	44	36	11	38	37			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	12	6	43	2	14	22		45	38	17	35	8			
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	12	7	45	2	3	6		46	40	12	1	2			
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	12	8	47	0	0	0	8	47	42	6	17	15			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	12	9	49	4	22	24	8	48	44	10	92	75			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	12	10	51	3	0	0	8	49	46	2	47	61			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	11	50	4	6	6	8	50	48	3	26	36			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	12	47	2	1	1	8	51	50	2	10	10			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	13	44	4	5	6	6	52	49	5	2	2			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	14	41	11	5	3									
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	15	38	4	13	13	6 54 43 6 0 0								
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	14	16	35	6	9	11	6	55	40	7	17	14			
16 18 36 2 11 12 4 57 37 5 29 25 16 19 38 3 7 7 4 58 39 4 13 16 16 20 40 7 23 29 4 59 41 3 4 5 16 21 42 5 48 21 4 60 43 0 0 0 16 22 44 2 0 0 4 61 45 4 33 11 16 23 46 2 0 0 4 62 47 4 12 10 16 24 48 2 1	16	17	34	6	24	19	6	56	37	4	127	35			
16193837745839413161620407232945941345162142548214604300016224420046145433111623462004624741210162448211111116255051615151615182649411111182746000111829408575656183037716161620313793128282032391026171720334166851X2035452411120364700010375026910384723310394442410	16	18	36	2	11	12	4	57	37	5	29	25			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	16	19	38	3	7	7	4	58	39	4	13	16			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	16	20	40	7	23	29	4	59	41	3	4	5			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	16	21	42	5	48	21	4	60	43	0	0	0			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	16	22	44	2	0	0	4	61	45	4	33	11			
16 24 48 2 1 1 16 25 50 5 16 15 18 26 49 4 1 1 18 27 46 0 0 0 18 28 43 4 0 0 18 28 43 4 0 0 18 29 40 8 57 56 18 30 37 7 16 16 20 31 37 9 31 28 20 32 39 10 26 17 20 34 43 2 72 57 20 35 45 2 4 11 20 36 47 0 0 0 10 37 50 2 6 9 10 38 47 2 3 3 10 39 44 4 24 10	16	23	46	2	0	0	4	62	47	4	12	10			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	16	24	48	2	1	1	Tet	$\frac{1}{1 \text{ for}}$	62	2.00	1205	067			
18 26 49 4 1 1 18 27 46 0 0 0 18 27 46 0 0 0 18 28 43 4 0 0 18 29 40 8 57 56 18 30 37 7 16 16 20 31 37 9 31 28 20 32 39 10 26 17 20 34 43 2 72 57 20 34 43 2 72 57 20 34 43 2 72 57 20 34 43 2 72 57 20 36 47 0 0 0 10 37 50 2 6 9 10 38 47 2 3 3 10 39 44 24 10 10 39<	16	25	50	5	16	15	fiel	as. Strot	02	299	1295	907			
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	18	26	49	4	1	1	1161	ua;							
18 28 43 4 0 0 18 29 40 8 57 56 18 30 37 7 16 16 20 31 37 9 31 28 20 32 39 10 26 17 20 33 41 6 68 51 20 34 43 2 72 57 20 34 43 2 72 57 20 35 45 2 4 11 20 36 47 0 0 0 10 37 50 2 6 9 10 38 47 2 3 3 10 39 44 4 24 10	18	27	46	0	0	0	т	forg	rain	hound	π	_π	299 Cm		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	18	28	43	4	0	0	^L A	IOI g	TOTI	bound	ary- 2 .F	L 2 ×6	2×0-55 Cut		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	18	29	40	8	57	56									
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	18	30	37	7	16	16	т. 4	or tr	rin h	ounda	rv=π×9	67	- 44.57, Cm		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	31	37	9	31	28	- A	.JI 19		Janua.	2 × (240.55	- 77 - 7 Cw2		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	32	39	10	26	17 ·	7 <u> </u>								
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	33	41	6	68	51	T f	or ar	ain 1	าดแทส์จ	rv = 4.8				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	34	43	2	72	57	a fa	-" 5" 1r σr:	ain b	ounda	rv = 3.0				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	35	45	2	4	11		- 5-			+y- J.U				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	20	36	47	0	0	0	T f	r twi	in ho	undar	v = 15.6				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	10	37	50	2	6	9	r fr	në turi	n ho	undar	y = 15.0 y = 17.1				
10 39 44 4 24 10	10	38	47	2	3	3					,				
	10	39	44	4	24	10	0								

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^{}*...**

TABLE 11 Precipitate Particle Density

<u>SAMPLE</u> SEMIX D-8. Sample in polished condition. Magnification 400X. Field area = 0.00149 cm^2

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A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIE	LD		А		В	FIE	LD		А		В			
Y	No.	x				Y	No.	x						
12	1	33	0		9	10	40	41	0		0			
12	2	35	0		10	10	41	38	1		0			
12	3	37	0	•	2	10	42	35	0	ĺ	11			
12	4	39	0		5	8	43	34	0		4			
12	5	41	1		0	8	44	36	0		1			
12	6	43	.0)	7		45	38	0		0			
12	7	45	0		17	8	46	40	1		1			
12	8	47	0		3	8	47	42	0		0			
12	9	49	0		4	8	48	44	1		0			
12	10	51	2		6	8	49	46	0		2			
14	11	50	0	ļ	2	8	.50	48_	0		2			
14	12	47	0		3	8	51	50	0		1			
14	13	44	0		1	6	52	49	0		8			
14	14	41	1		2	6 53 46 0 2								
14	15	38	0		0	<u>6 54 43 0 0</u>								
14	16	35	0		9	6	55	40	0		0			
16	17	34	1		1	6	56	37	0		7			
16	18	36	0		0	4	57	37	0		16			
16	19	3.8	0		4	4	58	39	0		6			
16	20	40	1		3	4	59	41	0		2			
16	21	42	0		7	4	60	43	0		4			
16	22	44	1		0	4	61	45	0		16			
16	23	46	0		5	4	62	47	0		3			
16	24	48	0		7	Tot	alfor	62	14	1	235			
16	25	50	0		8	fiel	4 a . A 101	02	1-1		200			
18	26	49	1		2	1161	us,				2			
18	27	46	0		1	Are	a of (62 fi	elds	= 0.0923	3 cm			
18	28	43	1		3	No.	of la	rge j	ppt. =	14/0.0	9238			
18	29	40	0	<u> </u>	_ _	-			=	152/ cr	1			
18	30	37	0		3	$\overline{\mathbf{X}}$ fo	or lar	ge p	pt. =	0.23				
20	31	37	0		6	σfo	or lar	ge p	pt. =	0.46				
20	32	39	0		3	No.	of sn	nall	ppt. =	235/0.	09238			
20	33	41	0		3	_			=	2544 / c	m"			
20	34	43	0		2	X fo	or sm	all p	opt. =	3,8				
20	35	45	1		2	o fo	r sm	all p	opt. =	4.0				
20	36	47	1		7									
10	37	50	0		1		. • .							
10	38	47	0		0	ORIGINAL PACE IS								
10	39	44	lo		1				OF P					

TABLE12DISLOCATION DENSITYSAMPLESEMIX D-8.Sample in etched conditionMagnification 1000X, Area of field = 0.000238 cm²XX and Y denote the location of microscope stage (field of view) for the
data measured.

27 Ly 7 8, 1 M

FIE	LD		No. o	f Disloca Pits	ation	FIE	LD		No.	of Disloca Pits	tion
Y	No.	x	T	•		Y	No.	x		₩.	
12	1	34		7		10	40	41		12	
12	2	35		5		10	41	38		7	
12	3	37		0		10	42	35		5	
12	4	39		9		8	43	35		2	
12	5	41		64		8	44	36		2	
12	6	43		7		8	45	38		15	
12	7	45		2		8	46	40		11	
12	8	47		8		8	47	42		304	
12	9	49		3		8	48	44		7	
12	10	50				8	49	46		2	
14	11	49		14		8	50	48		88	
14	12	47		6		8	51	49			
14	13	44		2		6	52	49		5	
14	14	41		3		6	53	46		34	
14	15	38		2		6	54	43		3	
14	16	35		4		6	55	40		48	
16	17	35	Į			6	56	37		2	
16	18	36		29		5	57	38			
16	19	38		5	· · · · · · · · · · · · · · · · · · ·	5	58	39		95	
16	20	40		10		5	59	41		6	
16	21	42		2		5	60	43		5	
16	22	44		9		5	61	45		14	
16	23	46		5		5	62	47		89	
16	24	48		7		Tot	al for	57		1377	•
16	25	49		6		fiel	ds:				
18	26	47		7							
18	27	46		8		Dis	locat	ion d	lensity	7	
18	28	43		142			· .				2
18	29	40				= 1	377 /	(57) (0.000	238) pits/0	cm ⁻
18	30	$\frac{37}{2}$			i	= 1	.0 x	10) pits	$/cm^2$ '	
19	31	37	+	6					~		
<u>19</u>	32	39	+	190		x :	= 24				
19	33	$\frac{41}{12}$			+	6	= 51				
19	34	43		<u>b</u>	+					•	
19	35	45	+		+						
19	36	47		10					~~~		1. THE 21. M
10	37	50		14					OR	IGINAL PAG	ie is
10	38	47		19	+				OF	POUR QUA	LITY
10	39	44	1	15							

TABLE 13 Grain Boundary and Twin Boundary Density

SAMPLE SEMIX E-13.Sample in polished condition. Magnification 100X. Field area = 0.0241 cm². Circumference of test circle = $\pi \cdot D$ = 0.55 cm. A denotes No. of grain boundary intersections with circumference of test circle. B denotes No. of twin boundary intersections with circumference of test circle. X and Y denotes field location of the data measured.

,

FIE	LD		А	No. of twins	В	FIE	ELD		А	No. of twins	В			
Y	No.	X				Y	No.	x						
12	1	33	4	7	7	10	40	41	2	170	124			
12	2	35_	2	5	7	10	41	38	5	27	29			
12	3	37	0	4	6	10	42	35	3	3	2			
12	4	39	0	1	2	8	43	34	5	0	0			
12	5	41	2	38	35	8 44 36 7 12 8 8 45 38 6 8 6 8 46 40 3 12 20								
12	6	43	0	0	0									
12	7	45	2	0	0									
12	8	47	0	0	0	8 47 42 2 8 15								
12	9	49	0	0	0	8	48	44	2	16	24			
12	10	51	0	0.	0	8	49	46	6	34	50			
14	11	50	0	0.	0	8	50	48	4	86	94			
14	12	47	0	1	1	8	51	50	3	102	161	1		
14	13	44	0	0	0	6	52	49	2	71	132			
14	14	41	0	0	0	6	53	46	4	92	152			
14	15	38	2	13	13	6	54	43	4	43	71			
14	16	35	0	4	7	6	55	40	4	26	38			
16	17	34	0	0	0	6	56	37	2	0	0			
16	18	36	4	6	3	4	57	37	3	2	2			
16	19	38	0	0	0	4	58	39	3	25	24			
16	20	40	2	15	15	4	59	41	3	33	45			
16	21	42	7	18	10	4	60	43	3	24	38			
16	22	44	6	20	17	4	61	45	7					
16	23	46	4	51	51	4	62	47	4	26	42			
16	24	48	6	33	39	Tat		62	152	1000	1400	l		
16	25	50	6	53	74	fiel	de.	02	155	1225	1400			
18	26	49	3	69	57	1161	us;							
18	27	46	2	10	11	т	ford	nain	, bound	π	, _π)	53 7 7 4 5 6 1		
18	28	43	0	0	0	A ^{LL} A	IOI g	lam	bound	2.1	L 2 xc	2×0.55 Cm		
18	29	40	0	0	0	1								
18	30	37	2	<u> </u>	0	т	for the	rin h	ounda	Tri	488	- 1 8.54 Cm		
20	31	37	0	0	0	"A			Junua	2 ×6	2 × 0.55	Cmb		
20	32	39	0	0	0						•			
20	33	41	0	0	0	$\overline{\nabla}$	07 77	ainl	hound					
20	34	43	0	0	0	ا کم رونیم	or gr	am i ain l	ounda	$x_{1}y - 2, 5$				
20	35	45	2	1	1		or gri	am r	Jounda	-y- 2.1				
20	36	47	2	8	7		~ * *	in h-	unda-					
10	37	50	3	21	17		01 (W)	DC in L-	unda -	y - 24	-			
10	38	47	2	4	4	010	OF TW	TT DC	Jundal	y - 37.7	ſ			
10	39	44	3	4	3									
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TABLE 14 Precipitate Particle Density

<u>SAMPLE</u> SEMIX E-13. Sample in polished condition. Magnification 400X. Field area = 0.00149 cm^2

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A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIE	LD		А		в	FIE	LD		А		В
Y	No.	x				Y	No.	X			
12	1	33	1		22	10	40	41	1		5
12	2	35	0		13	10	41	38	0		10
.12	3	37	0		7	10	42	35	0		4
12	4	39	0		18	8	43	34	0		48
12	5	41	2		15	8	44	36	0		13
12	6	43	2		12	8	45	38	0		4
12	7	45	2		15	8	46	40	0		8
.12	8	47	1		4	8	47	42	0		20
12	9	49	1		19	8	48	44	1	· ·	5
12	10	51	0		30	8	49	46	2	·	7
14	11	50	0		18	8	50	48	2		6
14	12	47	2		12	8	51	50	1		23
14	13	44	0		4	6	52	49	1		7
14	14	41	0		12	6	53	46	1		6
14	15	38	1		12	6	54	43	0		19
14	16	35	1		16	6	55	40	1		16
16	17	34	0		8	6	56	37	0		8
16	18	36	0		5	4	57	37	0		5
16	19	38	1		13	4	58	39	0		5
16	20	40	0		8	4	59	41	0		7
16	21	42	1		9	4	60	43	0		10
16	22	44	1		7	4	61	45	0		7
16	2.3	46	0		19	4	62	47	1		17
16	24	48	1		10	Tet		62	27		840
16	25	50	0		15	fiel	ar ior	02	51		040
18	26	49	1		11	TIC	us;				2
18	27	46	1		6	Are	ea of (62 fi	elds :	= 0.0923	8 cm
18	28	43	0		17	No.	of la	rge	ppt. =	37/0.0	19238
18	29	40	1	L	11				=	400/cm	ລ ້
18	30	37	0		21	X fo	or lar	ge p	pt. =	0.6	
20	31	37	0	ļ	9	σfe	or lar	ge p	opt. =	0.7 ·	
20	32	39	0	ļ	10	No.	of sn	nall	ppt. =	840/0.	09238
20	33	41	0		59				=	9090 / c	m ²
20	34	43	1		19	X fe	or sm	all j	ppt. =	13.5	
20	35	45	1	1	9	σfe	or sm	all j	ppt. =	10.6	
20	36	47	1		4			-			
10	37	50	0		27						
10	38	47	1		21						
10	39	44	2		3	N .		ORI	GINAL	PACE IS	

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TABLE15DISLOCATION DENSITYSAMPLESEMIX E-13.Sample in etched conditionMagnification 1000X, Area of field = 0.000238 cm²X and Y denote the location of microscope stage (field of view) for the
data measured.

FIE	LD		No. of Disloc Pits	ation	FIE	LD		No. of Dislocation Pits
Y	No.	X	+		Y	No.	X	4
12	1	34	175		10	40	41	242
12	2	35	141		10	41	38	93
12	3	37	245		10	42	35	68
12	4	39	56		8	43	35	295
12	5	41	39		8	44	36	97
12	6	43	19		8	45	38	58
12	7	45	<u> </u>		8	46	40	170
12	8	47	140		8	47	42	235
12	9	49	111		8	48	44	187
12	10	50	285		8	49	46	188
14	11	49	74		8	50	48	203
14	12	47	106		8	51_	49	102
14	13	44	6		6	52	49	
14	14	41	19		6	53	46	70
14	15	38	9		6	54	43	39
14	16	35	14		6	- 55	40	78
16	17	35	2	1	6	56	37	62
16	18	36	4	1	5	57	38	
16	19	38	24		5	58	39	22
16	20	40	2		5	59	41	22
16	21	42	32		5	60	43	35
16	22	44	6		5	61	45	38
16	23	46	38		5	62	47	
16	24	48	21					
16	25	49			Tota	101 101 1 101	56	4996
18	26	47	9		<u>ilei</u>	as :		
18	27	46	35		Dis	locati	ion d	ensity
18	28	43	14					<i></i> /
18	29	40	2		= 4	1996 /	(56) ($0.000238) \text{ pits/cm}^2$
18	30	37	11	ļ]		 F	5 2
19	31	37			= 3	8.7 ж	: 10	jits/cm
19	32	39			Į _			
19	33	41	11		x x	= 89		
19	34	43	52		S	= 96		
19	35	45	2		I			
19	36	47						
10	37	50	360					
10	38	47	370					ORIGINAL PAGE IS
10	39	44	250					OF POUR QUALITY

TABLE 16
SAMPLEGrain Boundary and Twin Boundary DensitySAMPLESEMIX F-2. Sample in polished condition. Magnification 100X.Field area = 0.0241 cm^2 . Circumference of test circle = π . D = 0.55 cm.A denotes No. of grain boundary intersections with circumference of test circle.B denotes No. of twin boundary intersections with circumference of test circle.X and Y denotes field location of the data measured.

FIE	ELD		А	No. of twins	в	FIE	LD	- 6	A	No. of twins	в		
Y	No.	X				Y	No.	x					
12	1	33	0	6	9	10	40	41	0	0	0]	
12	2	35	0	4	7	10	41	38	0	0	0		
12	3	37	0	0	0	10	42	35	0	0	0		
12	4	39	0	0	0	8	43	34	0	0	0		
12	5	41	2	0	0	8	44	36	0	0	0		
12	6	43	0	0	0		45	38	0	0	0		
12	7	45	0	0	0	8	46	40	0	0	0		
12	8	47	0	0	0	8	47	42	0	0	0	· ·	
12	9	49	0	2	4	8	48	44	0	0	0		
12	10	51	3	3	2	8	49	46	0	0	0]	
14	11	50	2	19.	28	8	50	48	0	2	4	.]	
14	12	47	0	0	0	8	51	50	0	0	0	1	
14	13	44	0	Q	0	6	52	49	0	1	2	1	
14	14	41	5	0	0	6	53	46	0	0	0	T	
14	15	38	5	0	0	6	54	43	0	0	0		
14	16	35	3	28	12	6	55	40	2	6	6	1	
16	17	34	2	30	27	6	56	37	0	0	0	1	
16	18	36	2	26 -	24	4	57	37	0	0	0	1.	
16	19	38	2	3	3	4	58	39	4	5	5	1	
16	20	40	4	10	12	4	59	41	5	19	13	1	
16	21	42	2	5	5	4	60	43	0	0	0	1	
16	22	44	0	0	0	4	61	45	0	0	0	1	
16	23	46	3	1	2	4	62	47	0	0	0		
16	24	48	6	12	10	Tett	1 6	62	110	207	2(4	4	
16	25	50	5	11	16		an ior	04	118	28 (204		
18	26	49	5	3	3	TIEL	us;						
18	27	46	3	2	3	Ŧ	fa		hound	π	, _ π ×	118	
18	28	43	5	5	4	A ^L A	tor g	rain	bound	$\frac{1}{2}$	L 2x	(2×0'55	
18	29	40	2	6	9	1							
18	30	37	3	46	22	т	or +	nin h	ounda	π x2	.64	- Ci	
20	31	37	3	3	5		OT TW		ounda	ry	62× 0155	= 12.16 =	
20	32	39	6	6	2						,		
20	33	41	9	10	8		~ n ' ~ -	- i - 1					
20	34	43	7	5	4			alli I	Jounda				
20	35	45	7	2	8	X for twin boundary = 4.3							
20	36	47	11	3	1								
10	37	50	0	0	0								
10	38	47	0	2	4	0.10	JE TW	n DC	undar	y = 0,0			
10	39	44	0	0	0								
		İ								we mand	iteril		

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<u>SAMPLE</u> SEMIX F-2. Sample in polished condition. Magnification 400X. Field area = 0.00149 cm^2

A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIE	LD		в		A	FIE	LD		B		Α		
Y	No,	X		2 		Y	No.	x					
12	1	33	11		1	10	40	41	42		0		
12	2	35	4		0	10	0						
12	3	37	35		3	10	10 42 35 15						
12	4	39	43		2	8		5					
12	5	41	2		0	8	44	36	7		2		
12	6	43	26		13	8	45	38	7		3		
12	7	45	3		0	8	46	40	4		2		
12	8	47	26		3	8	47	42	2		0		
12	9	49	6		1	8	48	44	0		0		
12	10	51	34		0	8	49		<u>ه</u>				
14	11	50	35		2	8	<u> </u>						
14	12	47	3		0	8	1						
14	13	44	3		1	6 52 49 0							
14	14	41	6		1	6	1						
14	15	38	8		0	6	54	43		þ			
14	16	35	0		0	6	55	40	6	<u>_</u>	2		
16	17	34	6		0	6	56	37	3		u		
16	18	36	1		3	4	57	37	.6		2		
16	1.9	3.8	5		0	4	58	39	2		0		
16	20	40	1		Ĩ	4	59	41	3		0		
16	21	42	2		0	4	60	43	2		1		
16	22	44	4		1	4	61	45	6		0		
16	23	46	5		0	4	62	47	0		0		
16	24	48	0		0	Tot	alfor	62	447	<u></u>	68		
16	25	50	1		2	fiel	41 101 41 101	02			00,		
18	26	49	0		1	1101					2		
18	27	46	0		0	Are	ea of é	52 fi	elds	= 0.09238	B cm		
18	28	43	1		0	No.	of la	rge j	ppt. =	68/0.0	9238		
18	29	40	1		2	_			=	736/ cm	1		
18	30	37	1		0	$\overline{\mathbf{X}}$ fo	or lar	ge p	pt. =	1.1			
20	31	37	3	,	0	σfc	or lar	ge p	pt. =	2.1			
20	32	39_	2		2	No.	of sn	nall	ppt. =	447/0.	09238		
20	33	41	1		0	_			=	4840 / ci	m"		
20	34	43	<u> 0</u>		<u> 1</u>	\mathbf{X} for small ppt. = 7.2							
20	35	45	0		<u>↓0;</u>	σ for small ppt. = 10.5							
20	36	47	4		0								
10	37	50	7	ļ	8								
10	38	47	ļ <u>1</u> ,	L	<u>0</u>			0p	1/210141	DAGE M			
10	39	44.	10					OF	POOP	PAGE IS			

DISLOCATION DENSITY

TABLE 18

SAMPLE SEMIX F-2. Sample in etched condition Magnification 1000X, Area of field = 0.000238 cm² X and Y denote the location of microscope stage (field of view) for the data measured.

FIE	LD		No. of	Disloca Pits	ation	F	IE	LD		No.	of Disloca Pits	ation
Y	No.	X		+		Y		No.	X		•	
12	1	34		7		10)	40	41		41	
12	2	35		0		10)	41	38		47	
12	3	37		15		10)	42	35		34	
12	4	39		14		8		43	35		22	
12	5	41		16		8		44	36		18	
12	6	43		7	•			45	38		2.2	
12	7	45		4		8_		46	40		37	
12	8	47		7		8		47	42		127	
12	9	49		2		8		48	44		58	
12	10	50		4		8		49	46		25	
14	11	49		6		8		50	48		38	
14	12	47		2		8		51	49		22	
14	13	44		4		6		52	49	ļ	16	
14	14	41		5		6		53	46	ļ	29	
14	15	38		5		6		54	43	 	68	+
14	16	35		12	•	6		55	40		16	
16	17	35		8		6		56	37		20	
16	18	36		3		5		57	38		21	
16	19	38		3		5		58	39		19	
16	20	40		13		5		59	41		45	
16	21	42		7		5		60	43		14	
16	22	44		5		5		61	45		26	
16	23	46		110		5		62	47		20	
16	24	48		1		T.	ote	al for	59	J	2334	
16	25	49		3		fi fi	مان ام	da.	5,			
18	26	47		9		li			******	· • •		•
18	27	46	<u> </u>	188		D	is	locat	ion d	lensit	y .	
18	28	43		9								, 2
18	29	40	┟───┼─	13	 	- 1	2	334/	(59) ((0.000	238 pits,	/cm
18	30	37	┟───┼─	47	ļ				7	5	, 2'	
19	31	37	┟		Į	=	1	.,7 ж	: 10	⁻ pits	s / cm ²	
19	32	39	<u> </u>		 	₩	•	-				
19	33	41	┟───┼	850		ų x	, =	= 40				
19	34	43	┟┣-	44		H O	' =	= 111			•	
19	35	45	┨┣-									
19	36	47				1						
10	37	50		23		4						
10	38	47		36	L							
10	39	44		31								

TABLE 19 Grain Boundary and Twin Boundary Density

SAMPLE SEMIX G-12. Sample in polished condition. Magnification 100X. Field area = 0.0241 cm², Circumference of test circle = π .D = 0.55 cm. A denotes No. of grain boundary intersections with circumference of test circle. B denotes No. of twin boundary intersections with circumference of test circle. X and Y denotes field location of the data measured.

• • •

A ... 2 8 8 1

FIE	LD		А	No. of twins	В	FIE	LD		А	No. of twins	В				
Y	No.	X				Y	No.	x							
12	1	33	2	6	9	10	40	41	6	39	11				
12	2	35	5	2	4	10	41	38	3	2.4	24				
12	3	37	2	3	3	10	42	35	3	6	2]			
12	4	39	5	13	16	8	43	34	3	6	6	Í			
12	5	41	2	4	3	8	44	36	2	22	22				
12	6	43	8	30	38	8	45	38	3	16	19	1			
12	7	45	8	74	100	8	46	40	8	2.6	17	1			
12	8	47	4	52	38	8	47	42	3	14	18]			
12	9	49	4	44	9	8	48	44	6	19	26	J			
12	10	51	6	79	42	8	49	46	3	45	34				
14	11	50	2	25 .	16	8	50	48	2		26				
14	12	47	3	7	7	8	51	50	0	5	10]			
14	13	4/4	5	0	0	6	52	49	0	7	5	I			
14	14	41	10	5	2	6	53	46	2	19	24				
14	15	38	2	4	2	6	54	43	8	38	40]			
14	16	35	0	0	0	6	55	120	7	24	18				
16	17	34	2	0	0	6	56	37	2	0	0				
16	18	36	5	6	3	4	57	37	8	13	6	1			
16	19	38	4	10	3	4	58	39	2	3	4				
16	20	40	8	10	5	4	59	41	6	16	9	I			
16	21	42	10	8	3	4	60	43	4	38	20	I			
16	22	44	4	1	1	4	61	45	5	33	22	1			
16	23	46	6	69	15	4	62	47	2	19	20				
16	24	48	3	12	2	Test		42	242	1157	991	▲			
16	25	50	4	16	16		at ior	02	202	1157	004				
18	26	49	4	30	8	1161	as:								
18	27	46	4	19	15		fa		haun	π	_π_*2	262			
18	28	43	0	0	0	A ^L	IOT g	, r a 111	Donne	2	L 2,5	241.55 2.07			
18	29	40	5	15	6										
18	30	37	7	20	5	τ.	for to	uin h	ounda	Tras	84	77 Cm			
20	31	37	9	11	13		101 69	VIII J	ounua	2 ×1	6240.55	= 40:12 - Cmr			
20	32	39	8	27	22					•	•				
20	33	41	3	12	10	$\overline{\nabla}$		in in 1	hound	1 2					
20	34	43	5	16	8		or ar	ain l	Jounda						
20	35	45	0	2	3	σ for grain boundary= 2.6 X for twin boundary = 14.3									
20	36	47	2	6	11										
10	37.	50	0	18	28										
10	38	47	9	22	111		OT IW	m oc	Junue I	y - 15.5	3				
10	39	44	4	32	24	H									
I						総			ORIG		F 18				

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TABLE 20Precipitate Particle Density

<u>SAMPLE</u> SEMIX G-12. Sample in polished condition. Magnification 400X. Field area = 0.00149 cm^2

A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIE	LD		A		В	FIE	LD		А	•	В
Y	No.	X				Y	No.	X			
12	1	33	0		16	10	40	41	0		6
12	2	35	0		18	10	41	38	0		9
.12	3	37	1		3	10	42	35	1		9
12	4	39	0		9	8	43	34	0		3
12	5	41	1		15	8	44	36	0		6
12	6	43	0		8	8	45	38	0		2
12	7	45	0		1	8	46	40	0		3
12	8	47	0		2	8	47	42	0		2
12	9	49	0		7	8	48	44	1		17
12	10	51	0		11	8	49	46	0		2
14	11	50	1		2	8	50	48	1		1,6
14	12	47	0		27	8	51	50	0		14
14	13	44	0		8	6	52	49	0		3
14	14	41	0		26	6	53	46	0		10
14	15	38	1		5	6	54	43	1		11
14	16	35	0		8	6	55	40	0		2
16	17	34	0		36	6	56	37	0		15
16	18	36	0		40	4	57	37	0		13
16	19	3.8	0		12	4	58	39	0		4
16	20	40	1		21	4	59	41	0		11
16	21	42	0		9	4	60	43	0		1
16	22	44	1		2	4	61	45	0		11
16	23	46	1		12	4	62	47	0		4
16	24	48	0		1	Tot		62	12		5.03
16	25	50	0		3	fiel	4e.	02	15		595
18	26	49	0		14						2
18	27	46	0		1	Are	ea of (62 fi	elds	≡ 0.09238	8 cm
18	28	43	1		9	No.	of la	rgej	ppt. =	13/0.0	9238
18	29	40	0		20	-			. =	140 / cm	້
18	30	37	0	ļ	12	X fo	or lar	ge p	pt. =	0.21	
20	31	37	0	ļ	7	e fo	or lar	ge p	pt. =	0,41	
20	32	39	<u>ρ</u>		5	No.	of sn	nall	ppt. =	593/0.	09238
20	33	41	0		6	(1			=	6420/c	m"
20	34	43	<u>0</u>		7	X fo	or sm	all p	opt. =	9.6	
20	35	45	0	ļ	0	σfo	or sm	all p	opt. =	8.0	
20	36	47	0	ļ	13	12					
10	37	50	<u> </u>	·	10						
10	38	47	1		4						
10	39	44	р.		9						

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TABLE21DISLOCATION DENSITYSAMPLESEMIX G-12.Sample in eland conditionMagnification 1000X, Area of field = 0.000238 cm²X and Y denote the location of microscope stage (field of view) for the
data measured.

FIELD		No. of Dislocation Pits		FII	ELD		No. of Dislocation Pits				
v	No	x		↓		v	No	x			
12	1	34				10	40	41	· · · · · · · · · · · · · · · · · · ·	33	
12	2	35		L		10	41	38		3	
12	3	37		2		10	42	35		3	
12	4	39		25		8	43	35			
12	5	41	()		8	44	36		0	
12	6	43	2	27		8	45	38		58	
12	7	45	. ()	·	8	46	40	<u> </u>	127	
12	8	47]	106		8	47	42		112	
12	9	49]	187		8	48	44		78	
12	10	50		182		8	49	46		135	
14	11	49]	125		8	50	48		15	
14	12	47]	158		8	51	49			
14	13	44		163		6	52	49		72	
14	14	41	- e	5		6	53	46		63	
14	15	38	(92		6	54	43		15	
14	16	35	2	23		6	55	40		2	
16	17	35	2	21		6	56	37		10	
16	18	36	4	19		5	57	38			
16	19	38	8	39		5	58	39		85	
16	20	40	6	53	2,	5	59	41		41	
16	21	42		10		5	60	43		70	
16	22	44	4	1 80		5	61	45		47	
16	23	46		310		5	62	47			
16	24	48		1000		Tet		55		5022	
16	25	49	(92		fiel	er iot	55		5952	
18	26	47	2	23							· · ·
18	27	46		2.2		Dis	locati	ion d	ensitv	,	
18	28	43		5			022 1			20)	lam^2
18	29	40	<u> </u>	.			1/ 267	(22)((. 0002	oo pits	
18	30	37	<u> </u>	74				1,5	-	l_{am}^{2} .	
19	31	37				= 4	E. O X	τU	pits	/ CIII	
19	32	39		108			_ 100				
19_	33	41		150			= 108 - 1/1	•			
19	34	43		±50		6	= 101				
19	35	45	⁴	<u> </u>		• •					
19	36	47									
10	37	50		320							
10	38	47	<i>i</i>	275							
10	39	44		6							

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-40 Filt#

TABLE 22
SAMPLEGrain Boundary and Twin Boundary DensitySAMPLESEMIX H-8, Sample in polished condition. Magnification 100X.Field area = 0.0241 cm². Circumference of test circle = π . D = 0.55 cm.A denotes No. of grain boundary intersections with circumference of test circle.B denotes No. of twin boundary intersections with circumference of test circle.X and Y denotes field location of the data measured.

FIE	LD		А	No. of twins	В	FIE	FIELD		А	No. of twins	в	
Y	No.	X				Y	No.	x				ł.
12	1	33	8	44	19	10	40	41	3	15	9	1
12	2	35	3	4	5	10	41	38	2	2	2	
12	3	37	4	9	8	10	42	35	5	15	13	
12	4	39	2	4	3	8	43	34	7	20	24	
12	5	41	5	6	6	8	44	36	6	17	17	Ì
12	6	43	2	10	11	8	45	38	3	4	4	l
12	7	45	2	1	2	8	46	40	3	1	1]
12	8	47	2	3	1	8	47	42	2	17	5]
12	9	49	5	13	12	8	48	44	5	54	39	
12	10	51	4	3	3	8	49	46	0	14	28	
14	11	50	2	10 .	12	8	50	48	4	9	11	
14	12	47	2	2	2	8	51	50	0	7	9	1
14	13	44	2	4	4	6	52	49	4	11	10	I
14	14	41	2	4	2	6	53	46	4	21	34	I
14	15	38	5	15	10	6	54	43	4	37	18	
14	16	35	3	12	15	6	55	40	7	8	11	
16	17	34	6	19	18	6	56	37	4	113	28	1
16	18	36	2	12	17	4	57	37	6	50	31	1
16	19	38	2	2	2	4	58	39	2	7	13	1
16	20	40	6	17	24	4	59	41	3	3	3	
16	21	42	6	39	34	4	60	43	0	0	0	í
16	22	44	0	1	2	4	61	45	6	35	6	
16	23	46	3	2	2	4	62	47	4	4	4	I
16	24	48	3	2	2	Tet	1	47	2.05	021	770	1
16	25	50	6	1	2		de.	02	205	951	119	
18	26	49	2	0	0	1161	us;					
18	27	46	0	0	0	т	for	main	hound	π	_π _x ;	205 - 84
18	28	43	3	6	8	A ¹¹ A	TOT B	1911	bound	2	L 2 46	240.55
18	29	40	3	4	45					,		
18	30	37	3	17	19	Т	for tu	- vin b	ounda	rv=x^	779	- 25.00 Cm
20	31	37	5	12	9	A A	LUI LV	, 111 D	Junua	2.*(62×0.55	- 33.08 Oni
20	32	39	4		18						•	
20	33	41	5	48	44	$\overline{\mathbf{v}}$	or ~*	ain	hound	rv= 2 2		
20	34	43	2	54	68	A 1	or ar	ain F	ounda	rv = 1 0		
20	35	45	2	13	13		or gr	14 1 1 1	Junud	-y- 1.7		
20	36	47	0	0	0	$\mathbf{\overline{\mathbf{x}}}_{\mathbf{f}}$	or tw	in he	undar	$v_{\rm r} = 12.4$		
10	37	50	2	4	5		or tw	in be	unda "	$y = 12_{*}0$	j	
10	38	47	0	0	0		UI LW.	TT DC	Jundal	y - 13.3	,	
10	39	44	3	13	6							
l	ł			1	1							

TABLE 23Precipitate Particle DensityOF POOR QUALITYSAMPLESEMIX H-8.Sample in polished condition.Magnification 400X.Field area= 0.00149 cm^2

A denotes No. of Large precipitates observed in field of view.

B denotes No. of Small precipitates observed in field of view.

X and Y denotes location of microscope stage for the data measured.

FIELD			А		В]	FIELD			A		В
Y	No.	х				3	7	No.	X			
12	1	33	2		48]	.0	40	41	0		10
12	2	35	2		3	1	.0	41	38	4		10
.12	3	37	0		13]	.0	42	35	0		38
12	4	39	0		7	8	3	43	34	0		41
12	5	41	0		9	8	3	44	36	0		19
12	6	43	1		14	<u> </u>	3	45	38	0		2.5
12	7	45	0		8	<u> </u>		46	40	0		12
12	8	47	0		5	8	3	47	42	1		7
12	9	49	1		6	8	3	48	44	0		11
12	10	51	1.		9	8	3	49	46	0		23
14	11	50	0		17		3	50	48	1		14
14	12	47	0		9	8	3	51	50	0		18
14	13	44	1		14	6	Ď.	52	49	0		19
14	14	41	0		19	6	, ,	53	46	0		34
14	15	38	0		11	(<u>,</u>	54	43	0		8
14	16	35	0		28	E	ś	55	40	0		4
16	17	34	1		14	e	5	56	37	0		9
16	18	36	0		5	4	1	57	37	1		13
16	19	3.8	0		3	4	1	58	39	0		9
16	20	40	0		4	4	4	59	41	0		6
16	21	42	0		11	4	4	60	43	0		16
16	22	44	0		1	4	4	61	45	0		17
16	23	46	0		5	4	4	62	47	0	1	15
16	24	48	0		7		0 - A	1	42	<u> </u>	<u> </u>	075
16	25	50	0	<u></u>	8		L'Oti Ci a 1	ai ior	02	23		815
18	2.6	49	0		3		ile.					2
18	27	46	0		110		Are	a of (62 fi	elds	= 0.0923	8 cm
18	28	43	3		18	1	No.	of la	rge j	ppt. =	23/0.0	9238
18	29	40	0		3		_			=	250/ cn	1 ~
18	30	37	0	L	14	1 3	ζfc	or lar	ge p	pt. =	0.4	
20	31	37	0		37	4	σfc	or lar	ge p	pt. =	0.8	
20	32	39	2		52		No.	of sn	nall	ppt. =	875 /0.	09238
20	33	41	0		<u> 11</u>	Į.				=	9470/c	m ²
20	34	43	0		22	¥ 3	κ fα	or sm	all I	ppt. =	14.1	
20	35	45	1		9		σfc	or sm	all j	opt. =	10.9	
20	36	47	0		15	1			~			
10	37	50	0		7	1						
10	38	47	0		3	1						
10	39	44	1		15							

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TABLE 24DISLOCATION DENSITYOF POOR QUALSAMPLESEMIX H-8.Sample in etched conditionMagnification 1000X, Azea of field = 0.000238 cm²XX and Y denote the location of microscope stage (field of view) for thedata measured.

FIELD		No. of Dislocation Pits		FIE	FIELD			No. of Dislocation Pits		
Y	No.	X	+		Y	No.	X		•	
12	1	34	138		10	40	41		164	
12	2	35	103		10	41	38		960	
12	3	37	4		10	42	35		72	
12	4	39	71		8	43	35			
12	5	41	197		8	44	36		49	
12	6	43	215		8	45	38		1050	
12	7	45	360		8	46	40		23	
12	8	47	222		8	47	42		725	
12	9	49	172		8	48	44		119	
12	10	50	155		8	49	46		325	
14	11	49	19		8	50	48		213	<u> </u>
14	12	47	3		8	51	49			·
14	13	44	78		6	52	49		255	· ·
14	14	41	6		6	53	46		32	
14	15	38	69		6	54	43		83	
14	16	35	125		6	55	40		1030	
16	17	35			6	56	37		3	
16	18	36	320		5	57	38			1
16	19	38	24		5	58	39		21	1
16	20	40	248		5	59	41		184	
+ 16	21	42	127		5	60	43		228	
16	22	44	17		5	61	45		270	
16	23	46	16		5	62	47			
16	24	48	2		Tot		56		11428	
16	25	49	2		fiel	ar ior	50		11420	
18	26	47	310			чь, 	· · •• · · ·			
18	27	46	189		Dis	locati	lon d	ensity		
18	28	43	271							, 2
18	29	40	425		= 1	1428/	(56)	(0.000)	238) pits	/cm
18	30	37	219	├		,	• -	5 .	, 2 ,	
19	31	37	111		= 8	.b x	5 10	pits	/cm	
19	32	39	303		X =	204				
19	33	41	82		s =	235				
19	34	43	300	 						
19	35	45	180							
19	36	47								
10	37	50	66							
10	38	47	307							
10	3.9	44	226							

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